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*Izsu AF/P*  
Request for Expedited Procedure  
Under 37 CFR § 1.116  
Group Art Unit: 1742  
Docket No.: M1071.1712/P1712  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:

Hidekiyo Takaoka et al.

Application No.: 10/087,786

Art Unit: 1742

Filed: March 5, 2002

Examiner: S. Ip

For: LEAD FREE SOLDER AND SOLDERED  
ARTICLE

*OK  
40 Letter  
2/14/05  
AEI*

**AMENDMENT IN RESPONSE TO FINAL ACTION**

**INTRODUCTORY COMMENTS**

In response to the Office Action dated September 8, 2004, please reconsider the above-identified U.S. patent application amended as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 6 of this paper.